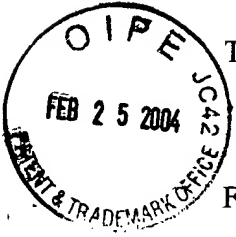


Application no.09/945,432  
Amdt. dated January 26, 2004  
Reply to Communication of December 22, 2003

Image  
TSMC-00-523

AF  
2812

January 26, 2004



TO: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

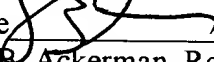
SUBJECT: Serial #: 09/945,432  
File Date: September 4, 2001  
Inventor: Chung Liu  
Examiner: Nguyen, Ha T  
Art Unit: 2812 Title: Novel Mesh Pad...

### RESPONSE TO COMMUNICATION

This is in response to the Communication dated December 22, 2003. Please amend  
the above identified application for patent as follows.

### CETIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States  
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents  
and Trademarks, Washington, D.C. 20231 on February 23, 2004.

Signature   
Stephen B. Ackerman, Reg. No. 37,761

Date 2/23/04

Application no.09/945,432

TSMC-00-523

Amdt. dated January 26, 2004

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Amendments to the Claims are reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 9 of this paper.